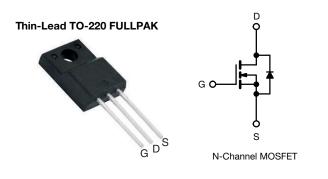
## SiHA24N65EF

**Vishay Siliconix** 

## **E Series Power MOSFET with Fast Body Diode**



www.vishay.com

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700				
R <sub>DS(on)</sub> max. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.156				
Q <sub>g</sub> max. (nC)	122				
Q <sub>gs</sub> (nC)	17				
Q <sub>gd</sub> (nC)	36				
Configuration	Single				

### FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t<sub>rr</sub>, Q<sub>rr</sub>, and I<sub>RRM</sub>
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Low switching losses due to reduced Q<sub>rr</sub>
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### APPLICATIONS

- Telecommunications
  - Server and telecom power supplies
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Consumer and computing
  - ATX power supplies
- Industrial
  - Welding - Battery chargers
- Renewable energy
  - Solar (PV inverters)
- Switch mode power supplies (SMPS)
- · Applications using the following topologies
  - LCC
  - Phase shifted bridge (ZVS)
  - 3-level inverter
  - AC/DC bridge

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free	SiHA24N65EF-E3			
Lead (Pb)-free and halogen-free	SiHA24N65EF-GE3			

<b>ABSOLUTE MAXIMUM RATINGS (T</b> <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	650	- V	
Gate-source voltage			V <sub>GS</sub>	± 30		
Continuous durin current (T 150 °C) 6	N	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	I <sub>D</sub>	10		
Continuous drain current ( $T_J = 150 \ ^\circ C$ ) $^e$	$V_{\text{GS}}$ at 10 V	T <sub>C</sub> = 100 °C		6	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	65		
Linear derating factor				0.31	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	691	mJ	
Maximum power dissipation			P <sub>D</sub>	39	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	T <sub>J</sub> = 1	25 °C	-1) / /-14	70	1//	
Reverse diode dV/dt <sup>d</sup>			dV/dt	50	V/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	for 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 28.2 mH,  $R_q = 25 \Omega$ ,  $I_{AS} = 7$  A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , dl/dt = 900 A/µs, starting  $T_J$  = 25 °C

e. Limited by maximum junction temperature

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COMPLIANT

HALOGEN FREE



THERMAL RESISTANCE RAT	INGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R <sub>thJA</sub>	- 65 - 3.2					°C / M		
Maximum junction-to-case (drain)	R <sub>thJC</sub>					- °C/W			
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ ,	unless otherwi	ise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT		
Static	•					•	•	1	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μA	650	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.68	-	V/°C	
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	2	-	4	V	
		,	$V_{GS} = \pm 20$	V	-	-	± 100	nA	
Gate-source leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 30$	V	-	-	± 1	μA	
Zerren et al. alle et al. al estat		V <sub>DS</sub> =	= 520 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	μA	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 520 V	′, V <sub>GS</sub> = 0 V	′, T <sub>J</sub> = 125 °C	-	-	500		
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	ار	<sub>0</sub> = 12 A	-	0.13	0.156	Ω	
Forward transconductance	g <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> =	= 12 A	-	7.2	-	S	
Dynamic						•	•		
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V	_	-	2774	-		
Output capacitance	C <sub>oss</sub>	$V_{\text{GS}} = 100 \text{ V},$ $V_{\text{DS}} = 100 \text{ V},$ f = 1  MHz		-	128	-	pF		
Reverse transfer capacitance	C <sub>rss</sub>			-	4	-			
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 520 V, $V_{GS}$ = 0 V		-	96	-			
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	333	-			
Total gate charge	Qg				-	81	122		
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 12 \text{ A}, V_{DS} = 520 \text{ V}$		-	17	-	nC		
Gate-drain charge	Q <sub>gd</sub>	1			-	36	-	1	
Turn-on delay time	t <sub>d(on)</sub>				-	24	48		
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	V <sub>DD</sub> = 520 V, I <sub>D</sub> = 12 A,		-	34	68		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	80	120	ns		
Fall time	t <sub>f</sub>			-	46	92			
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.2	0.5	1.0	Ω		
Drain-Source Body Diode Characterist	ics								
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	24			
Pulsed diode forward current	I <sub>SM</sub>			-	-	65	A		
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 12 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V		
Reverse recovery time	t <sub>rr</sub>				-	151	288	ns	
Reverse recovery charge	Q <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 12 \text{ A}, \\ dI/dt = 100 \text{ A}/\mu\text{s}, V_{R} = 400 \text{ V}$		-	0.9	2.1	μC		
Reverse recovery current	I <sub>RRM</sub>			-	13	-	A		

### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

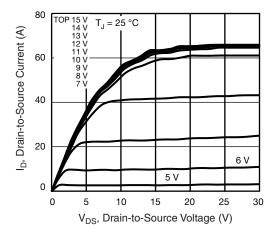


Fig. 1 - Typical Output Characteristics

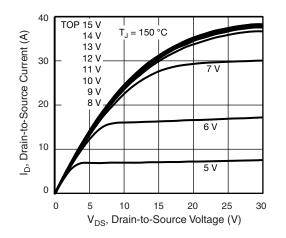


Fig. 2 - Typical Output Characteristics

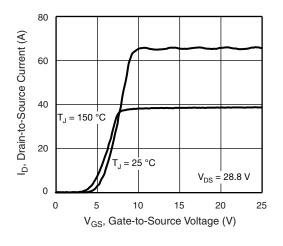


Fig. 3 - Typical Transfer Characteristics

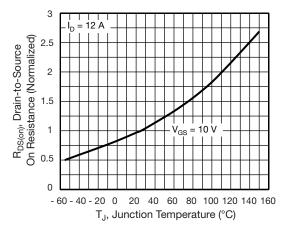


Fig. 4 - Normalized On-Resistance vs. Temperature

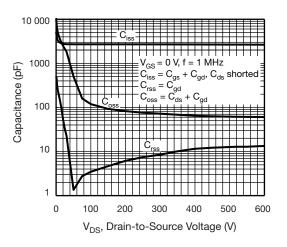


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

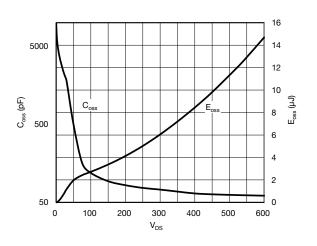


Fig. 6 -  $C_{\text{oss}}$  and  $E_{\text{oss}}$  vs.  $V_{\text{DS}}$ 

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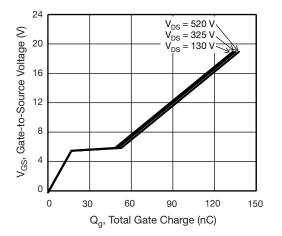


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

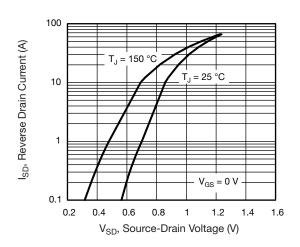
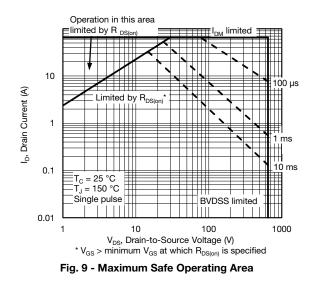


Fig. 8 - Typical Source-Drain Diode Forward Voltage



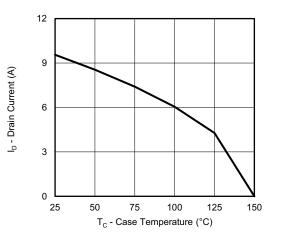
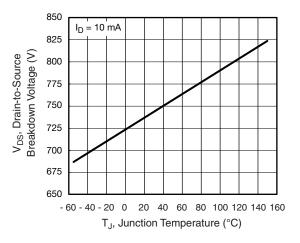


Fig. 10 - Maximum Drain Current vs. Case Temperature





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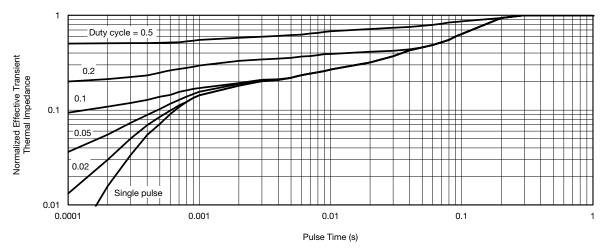
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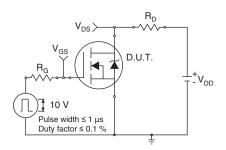


Fig. 13 - Switching Time Test Circuit

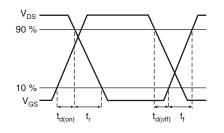


Fig. 14 - Switching Time Waveforms

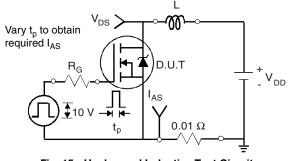
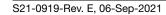


Fig. 15 - Unclamped Inductive Test Circuit



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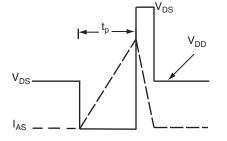


Fig. 16 - Unclamped Inductive Waveforms

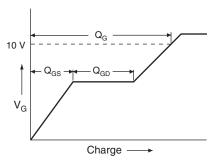
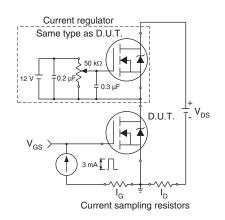
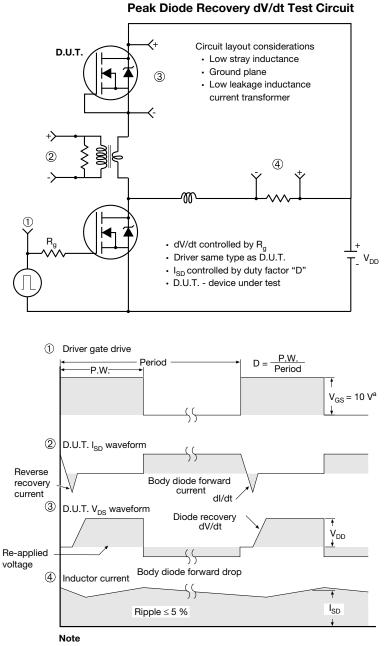


Fig. 17 - Basic Gate Charge Waveform





### Fig. 18 - Gate Charge Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 19 - For N-Channel

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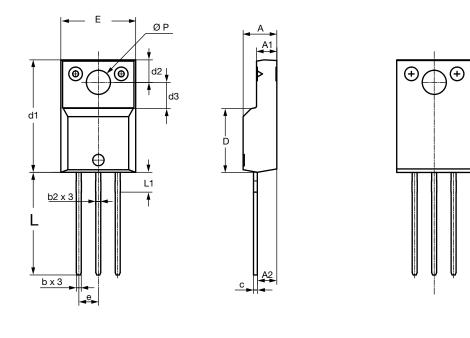
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# **TO-220 FULLPAK Thin Lead**





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	•		

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